## OMRON

# Photomicrosensor (Reflective) EE-SY169

#### Dimensions

Note: All units are in millimeters unless otherwise indicated.



#### Internal Circuit



Terminal No.NameAAnodeKCathodeCCollectorEEmitter

2.5 Note: These dimensions are for the surface A. Other lead wire pitch dimensions are for the housing surface. Unless otherwise specified, the tolerances are as shown below. Dimensions Tolerance

Dimensions	TOTETATICE
3 mm max.	±0.3
$3 < mm \le 6$	±0.375
6 < mm ≤ 10	±0.45
$10 < mm \le 18$	±0.55
18 < mm ≤ 30	±0.65

#### Features

- High-quality model with plastic lenses.
- $\bullet$  Highly precise sensing range with a tolerance of  $\pm 0.6$  mm horizontally and vertically.
- With a red LED sensing dyestuff-type inks.
- Limited reflective model.
- For lesser LED forward current, use EE-SY169B.
- RoHS Compliant.

#### ■ Absolute Maximum Ratings (Ta = 25° C)

	Item	Symbol	Rated value
Emitter	Forward current	I <sub>F</sub>	40 mA (see note 1)
	Pulse forward current	I <sub>FP</sub>	300 mA (see note 2)
	Reverse voltage	V <sub>R</sub>	3 V
Detector	Collector–Emitter voltage	V <sub>CEO</sub>	30 V
	Emitter–Collector voltage	V <sub>ECO</sub>	
	Collector current	I <sub>C</sub>	20 mA
	Collector dissipation	P <sub>C</sub>	100 mW (see note 1)
Ambient temperature	Operating	Topr	0° C to 70° C
	Storage	Tstg	–20° C to 80° C
Soldering temperature		Tsol	260°C (see note 3)

Note: 1. Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

- 2. The pulse width is 10  $\mu s$  maximum with a frequency of 100 Hz.
- Complete soldering within 10 seconds.

#### Ordering Information

Description	Model	
Photomicrosensor (reflective)	EE-SY169	

### ■ Electrical and Optical Characteristics (Ta = 25°C)

Item		Symbol	Value	Condition
Emitter	Forward voltage	V <sub>F</sub>	1.85 V typ., 2.3 V max.	I <sub>F</sub> = 20 mA
	Reverse current	I <sub>R</sub>	0.01 μA typ., 10 μA max.	V <sub>R</sub> = 3 V
	Peak emission wavelength	λ <sub>P</sub>	660 nm typ.	I <sub>F</sub> = 20 mA
Detector L L C V V W	Light current	I <sub>L</sub>	160 μA min., 2,000 μA max.	$I_F = 20 \text{ mA}, V_{CE} = 5 \text{ V}$ White paper with a reflection ratio of 90%, d = 4 mm (see note)
	Dark current	I <sub>D</sub>	2 nA typ., 200 nA max.	V <sub>CE</sub> = 5 V, 0 ℓx
	Leakage current	I <sub>LEAK</sub>	2 μA max.	$I_F = 20 \text{ mA}, V_{CE} = 5 \text{ V}$ with no reflection
	Collector–Emitter saturated voltage	V <sub>CE</sub> (sat)		
	Peak spectral sensitivity wavelength	λ <sub>P</sub>	850 nm typ.	V <sub>CE</sub> = 5 V
<b>Rising time</b>		tr	30 μs typ.	$V_{CC} = 5 \text{ V}, \text{ R}_{L} = 1 \text{ k}\Omega, \text{ I}_{L} = 1 \text{ mA}$
Falling time	)	tf	30 μs typ.	$V_{CC} = 5 \text{ V}, \text{ R}_{L} = 1 \text{ k}\Omega, \text{ I}_{L} = 1 \text{ mA}$

Note: The letter "d" indicates the distance between the top surface of the sensor and the sensing object.